Full product information on Zarlink's new *Class*Switch platform of single-chip, full-service Layer 2 Ethernet switches, including full data sheets and design manuals, is available to qualified customers. To learn how to become a qualified customer, please send an email to PacketSwitching@Zarlink.com. Alternatively, please contact your local sales representative.



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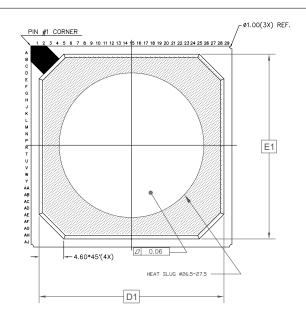
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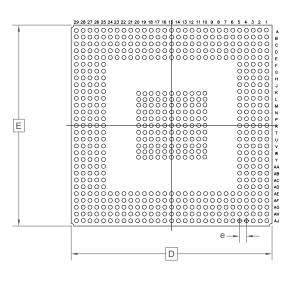
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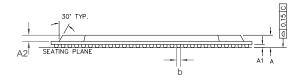
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DIMENSION	I MIN	MAX			
Α	2.20	2.46			
A1	0.50	0.70			
A2	1.17 REF				
D	37.30	37.70			
D1	34.50 REF				
E	37.30	37.70			
E1	34.50 REF				
b	0.60	0.90			
е	1.27				
N	601				
Conforms to JEDEC MS - 034					



NOTE:

- 1. CONTROLLING DIMENSIONS ARE IN MM
- 2. DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER
- 3. SEATING PLANE IS DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 4. N IS THE NUMBER OF SOLDER BALLS
- 5. NOT TO SCALE.
- 6. SUBSTRATE THICKNESS IS 0.56 MM

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ISSUE	1				Previous package codes:	Package Outline for 601 Ball
ACN				ZARLINK SEMICONDUCTOR		HSBGA (37.5x37.5x2.33mm)
DATE	6 Nov03			SEWITCONDUCTOR	,	
APPRD.						102076



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